

APPROVAL SHEET

To :

Customer P/N :

UDE P/N : S52-ZZ-0004

Description : RJ45 1X1 Tab Up

Through Hole

2.5G Base-T

Contact Area : Gold Flash

LED :L-Green; R-Yellow

Packing With Hard Tray



Spec No.
S5220005-00

Update Date
2020/7/9

Revision
B

Approved	Checked	Prepared



湧德電子 股份有限公司
UDE Corp.

桃園市(33852) 蘆竹區內溪路 68 巷13號

No.13, Ln. 68, Neixi Rd., Luzhu Dist., Taoyuan City (33852), Taiwan

TEL: 886-3-3242000 FAX: 886-3-3246611

<http://www.ude-corp.com/>

Revision History

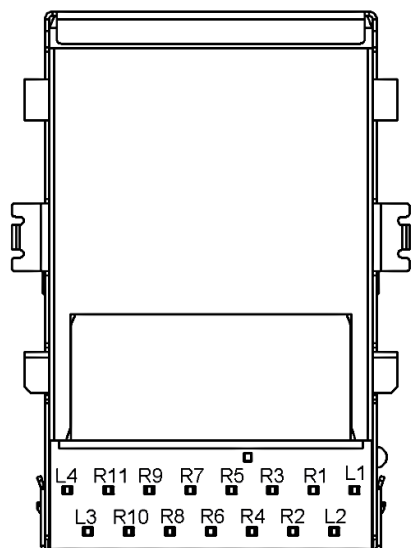
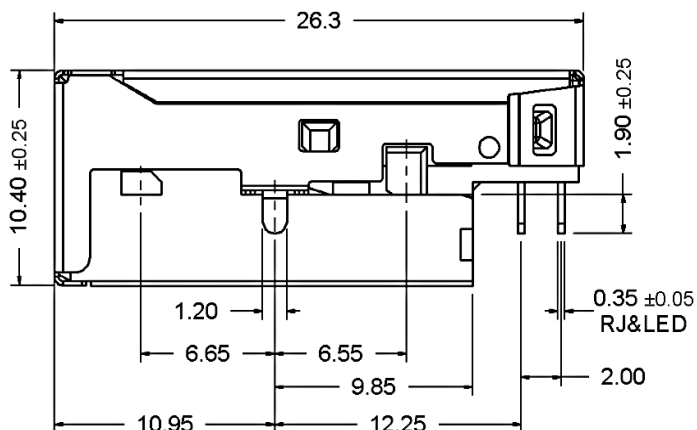
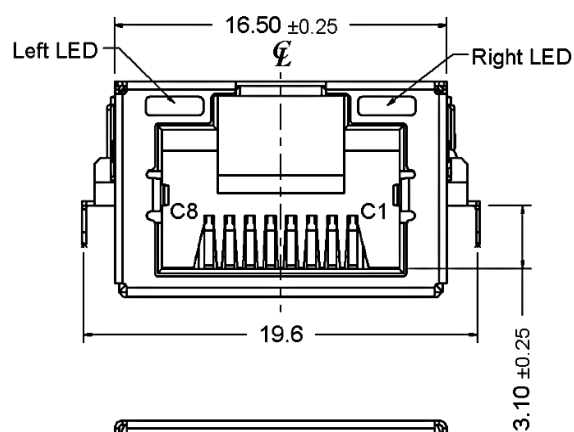
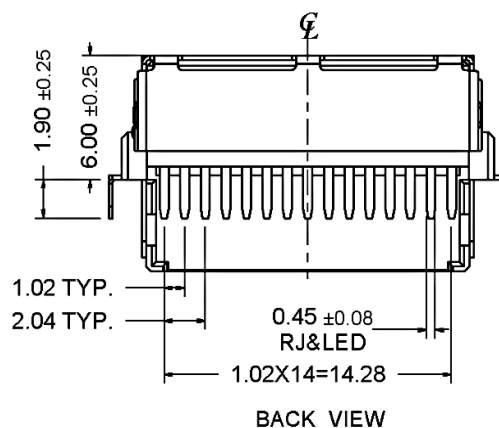
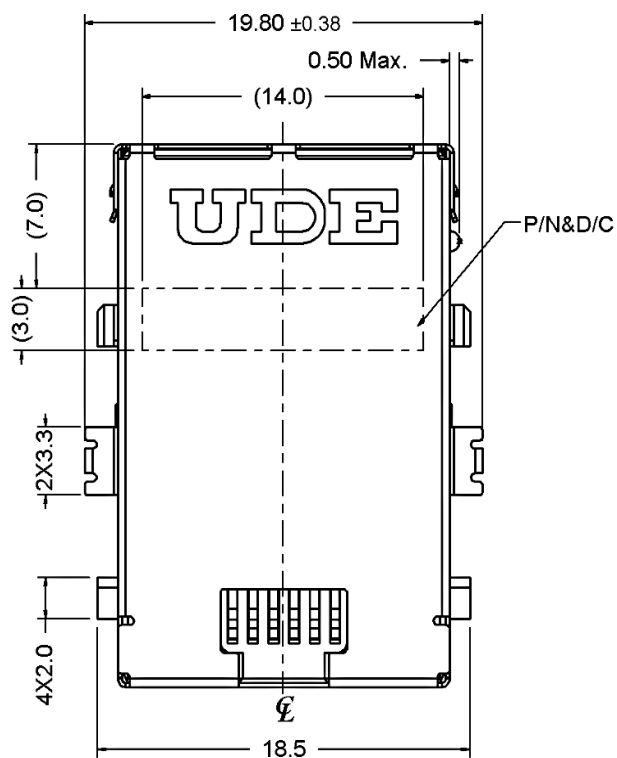
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1. MECHANICAL DIMENSION

Product Dimension

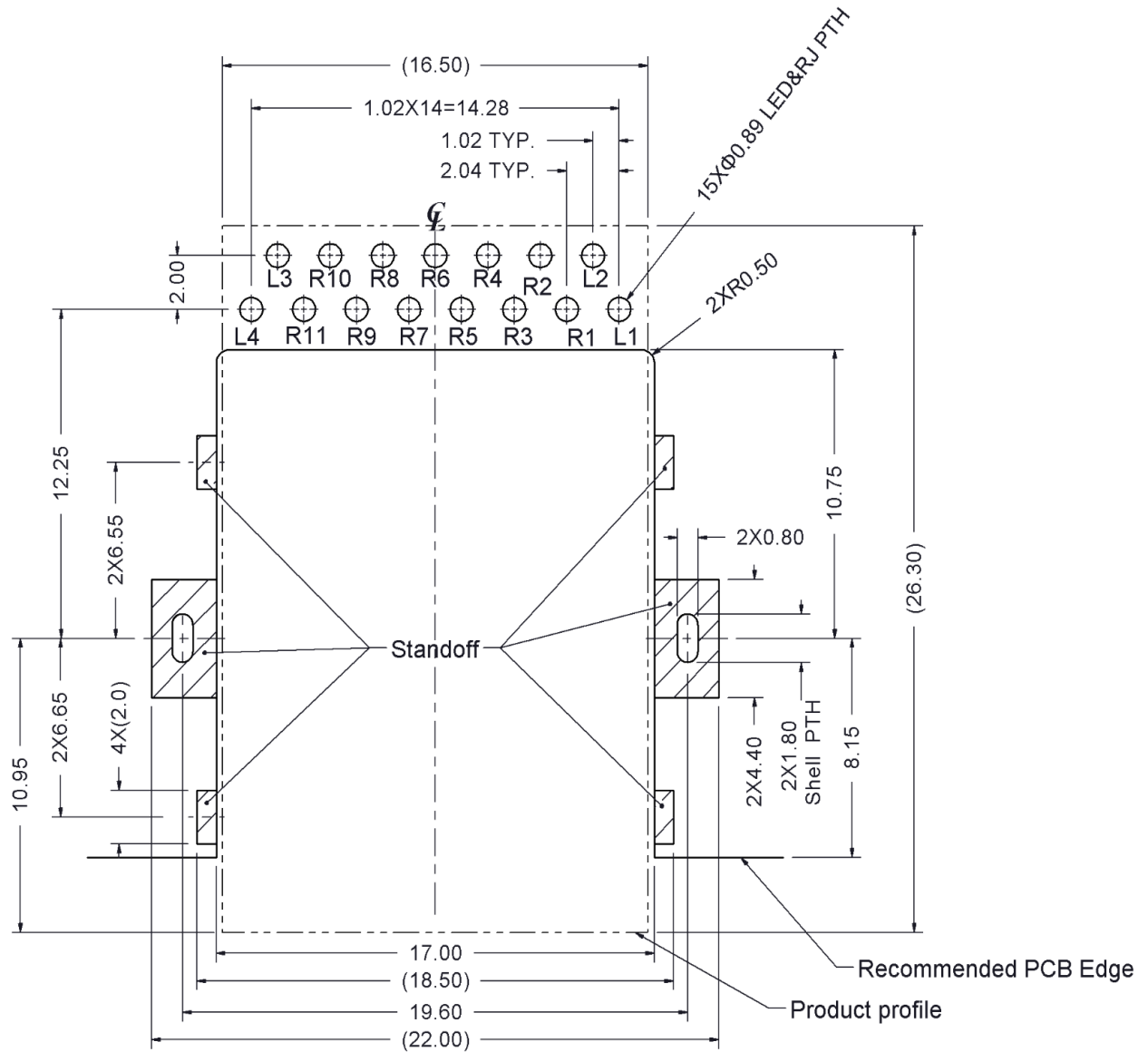
Unit:mm

General Tolerance : X.X : ± 0.38
 X.XX : ± 0.20

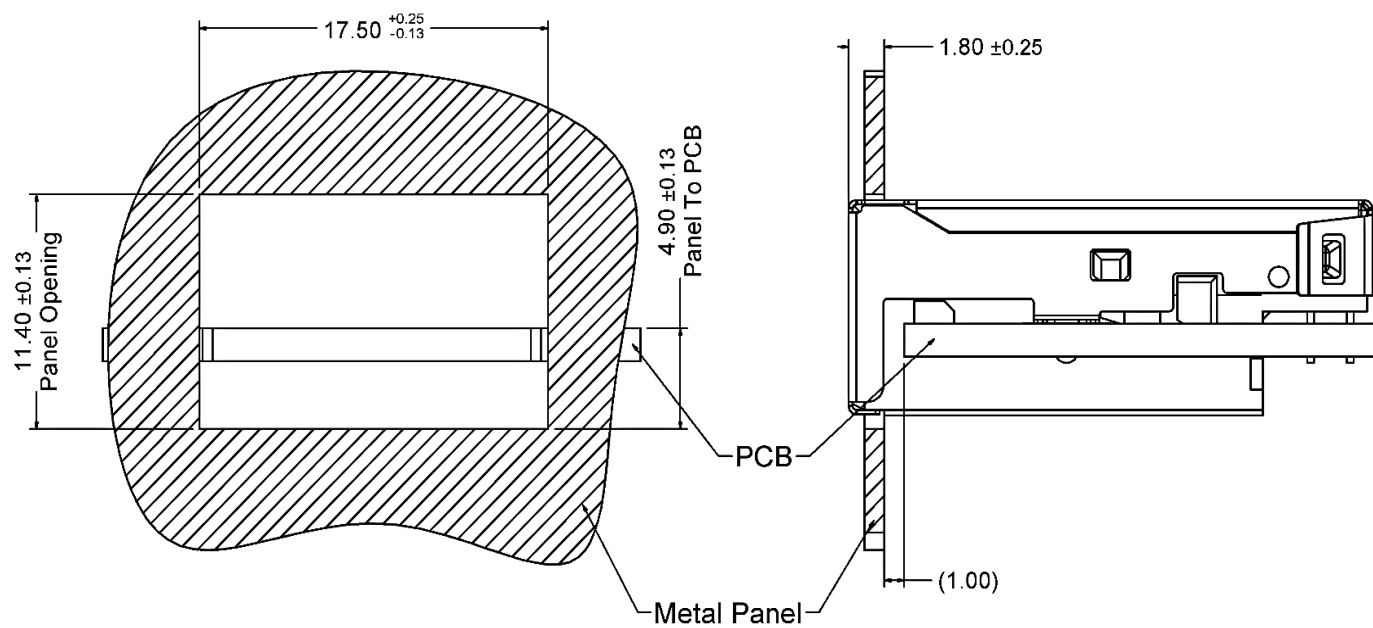


Recommended PCB Layout. Component side of board

All dimension units are "mm".

All dimension tolerances are $\pm 0.05\text{mm}$ unless otherwise specified.

Recommended Panel cutout



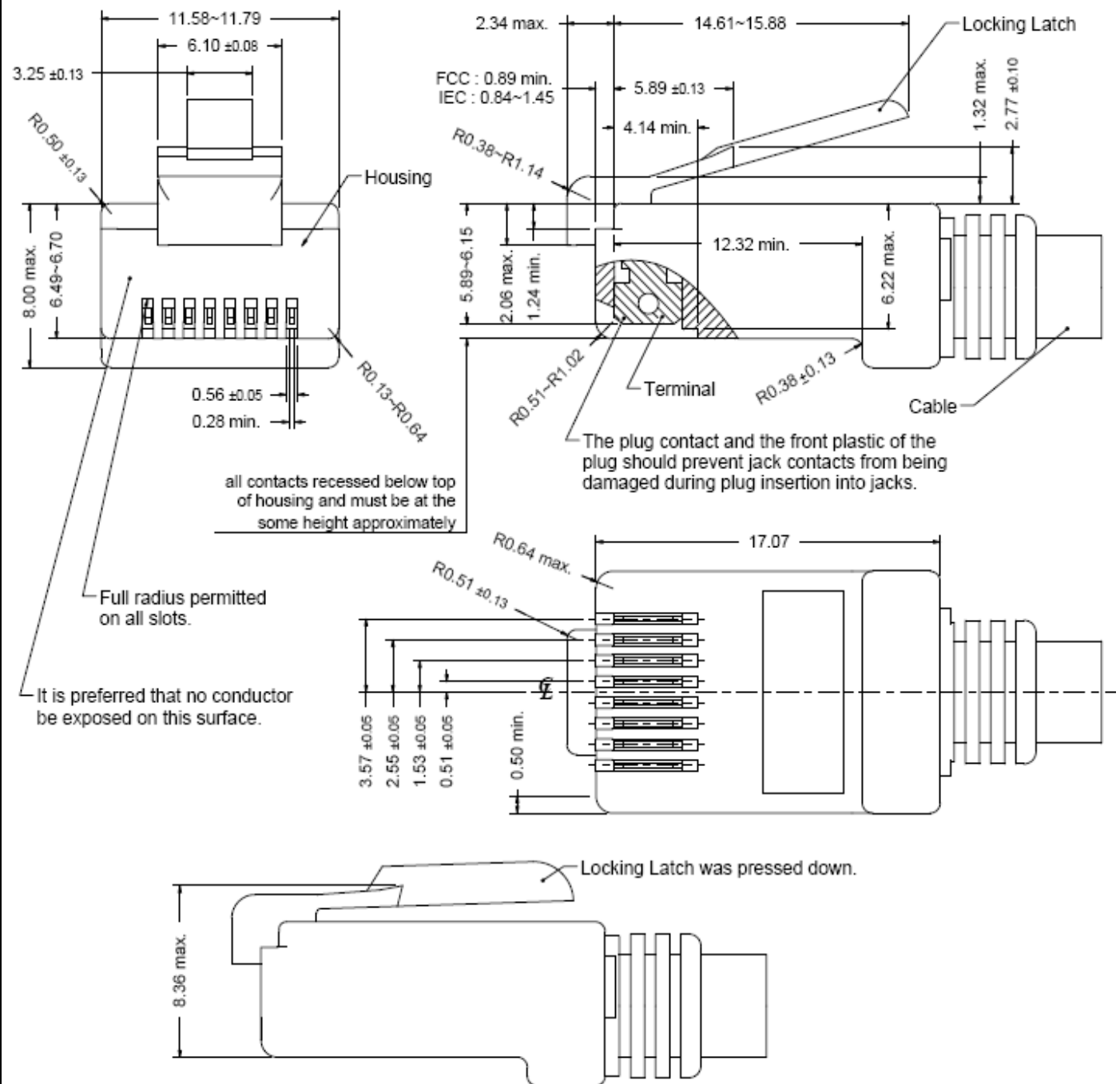
2. Packing Information

50 pcs finished goods per tray

16 trays(750 pcs finished goods) per inner box

4 Inner boxes(3000 pcs finished goods) per master carton

3. Standard RJ45 Plug Specification



- All dimensions follow :
FCC subpart F, 68,500, Figure (C)(2)(i) & (C)(2)(ii) & (C)(3)(i)
IEC 60603-7
- All plugs must be meeting the requirements of plug Go & No-Go gauge.
Gauge follow : FCC subpart F, 68,500, Figure (C)(4)(i) & (C)(5)(i)
- There must be no damage to Housing and Locking Latch.
- There must be no nicks and cuts in cable.
- Durability : 750 cycles generally

4. REQUIREMENTS

Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable.

Material

Terminal Parts (Underplating : 50 μ "min Nickel overall)

RJ Terminal : Phosphor Bronze , Thickness=0.25mm

Finish : Contact Area : Gold Flash

Input Terminal : Brass, Thickness=0.35mm

Finish : 100 μ " min. Matte Tin

Capacitance Terminal : Phosphor Bronze, Thickness=0.35mm

Finish : 100 μ " min. Matte Tin

Plastic Parts <UL94V-0>

Housing : PA9T, Black

Case : PA6T, Black

LED Cover : PA6T, Black

Shield Parts

Shield Parts : Phosphor Bronze, Thickness=0.20mm

Finish : 30 μ " min. Nickel overall

5. Operating and Storage Temperature

Operating Temperature : 0°C to +70°C

Storage Temperature : -40°C to +85°C

6. RJ45 specifications

Insulation Resistance : 500MΩ min.

Insertion force with the latch depressed : 20N max.

Removal force with the latch depressed : 20N max.

Locking Force of Plug Latch : 50N min. @ 60+/-5 sec.

Durability : 750 cycles

7. Performance and Test Description

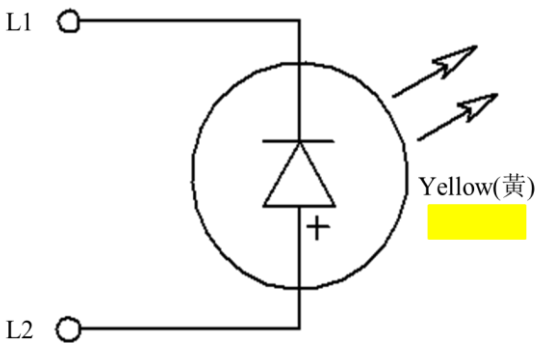
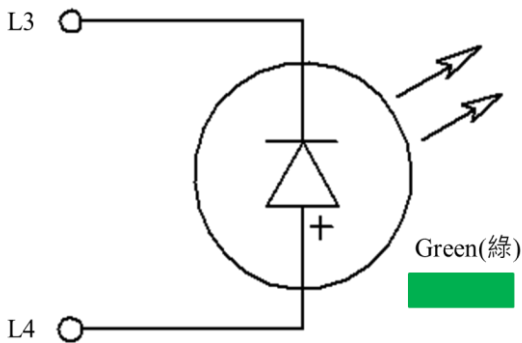
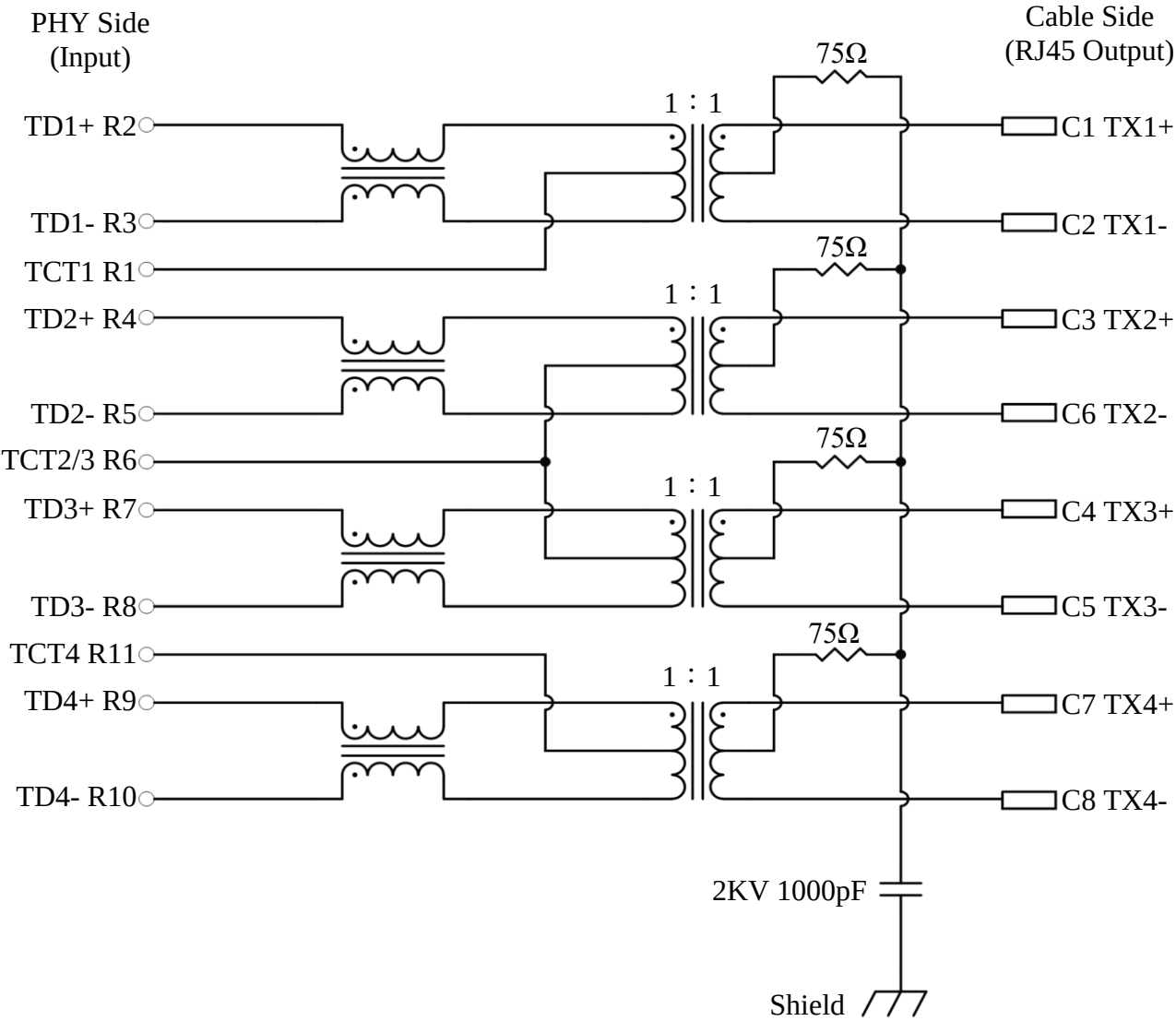
Product is designed to meet electrical, mechanical and environmental performance requirements specified in below table.

All tests are performed at ambient environmental conditions per MIL-STD-1344A and EIA-364 unless otherwise specified.

8. Packaging and Packing

All parts shall be packaged and packed to protect against physical damage, corrosion and deterioration during shipment and storage.

9. ELECTRICAL CHARACTERISTCS @25°C



Emitting Color	λ_p (nm)	V_f @ $I_f=20mA$	I_r @ $V_r=5V$
Green	570	1.7 ~2.6 V	10 μ A max.
Yellow	588	1.7 ~2.6 V	10 μ A max.

Transmitter filter & Receiver filter

Type : Balance low pass 100Ω impedance

Insertion loss : 1~50MHz -0.5dB max.

50~125MHz -1.0dB max.

125~200MHz -2.0dB max.

Return loss : 1~40MHz -20dB min.

40~200MHz $-20+15*\log(\text{Freq MHz}/40\text{MHz})$ dB min.

Reflected CM to Diff Conversion(REF)

1MHz -30dB min.

50MHz -30dB min.

100MHz -27dB min.

200MHz -24dB min.

CM to DM Conversion(REF)

1-50MHZ -35 dB min

125MHZ -30 dB min

200MHZ -25 dB min

Reflected Diff to CM Conversion(REF)

1-10MHZ -48 dB min

10-200MHz $-48+19*\log(\text{Freq MHz}/10\text{MHz})$ dB min

CM to CM Attenuation (REF)

1-200MHZ -25 dB min

Cross Talk

1~40MHz -35dB min.

40~125MHz $-35+15\log((\text{Freq MHz}/40\text{MHz}))$ dB min.

Inductance (OCL) @ 100KHz, 0.1V, 8mA DC BIAS

Input(TD1+,TD1-) ; (TD2+,TD2-) ; (TD3+,TD3-) ; (TD4+,TD4-) : 180 μH min.

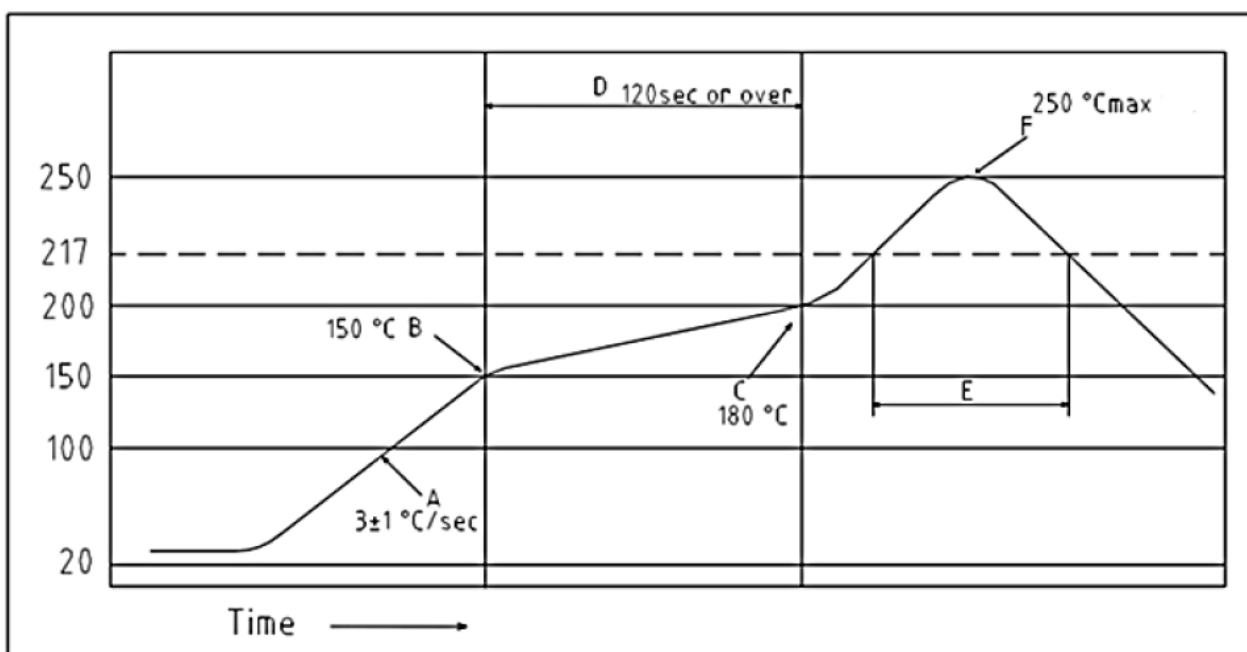
HiPot Test

PHY Side(input) To Cable Side(output) : 1500Vac 60s or 2250Vdc 60s

10. IR REFLOW TEMPERATURE PROFILE

Temperature condition of reflow soldering

Contents	Soldering Condition
A : Increasing speed	$3\pm 1^{\circ}\text{C}/\text{sec}$
B : Pre-heat starting Temp	150°C
C : Pre-heat ending Temp	180°C
D : Pre-heat interval	120 sec or over
E : Over 217°C time	60 ~ 150 sec
F : Peak Temperature	250°C max. 10sec



Type of lead-free solder should be 96.5Sn-3.0Ag-0.5Cu or 99.3Sn-0.7Cu.